

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK
 LATCH: SUS, TIN PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 250V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 500M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -55°C~+85°C

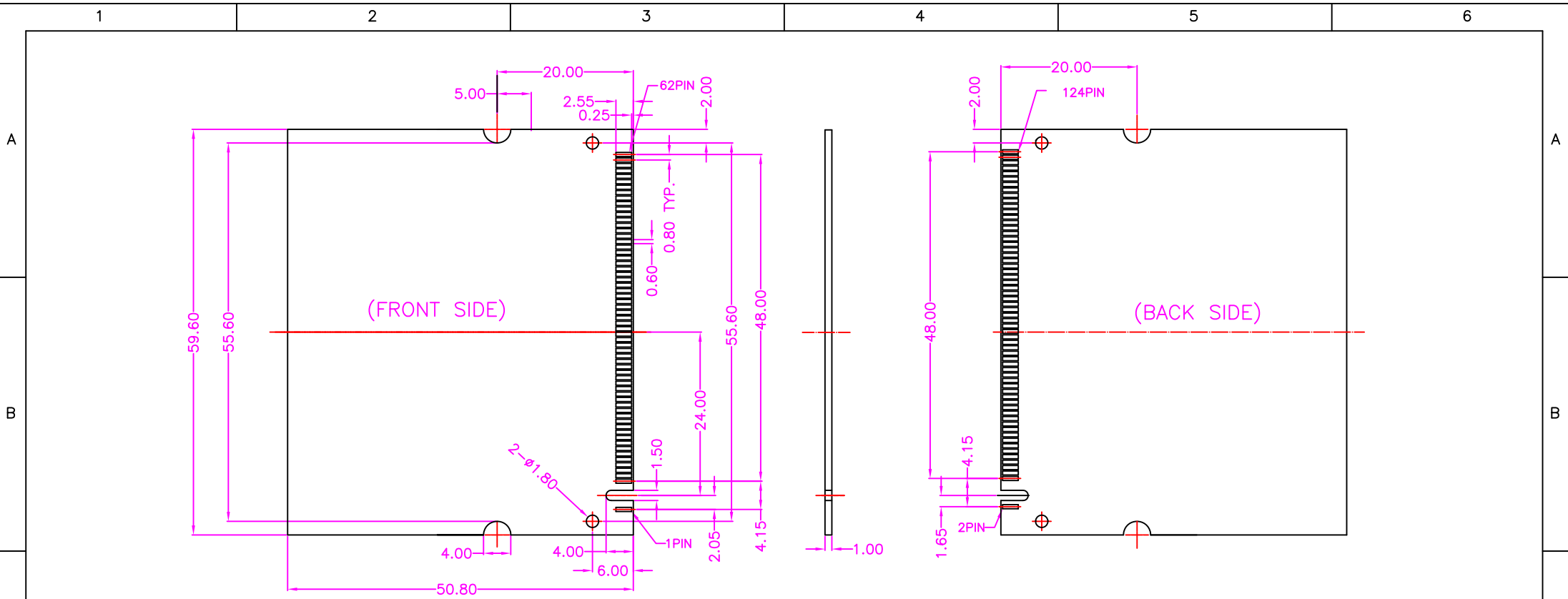
PART NUMBER:

MMSLF - 1 2 4 * T - 1 * 3

SERIES ————
 NO. OF POS. ————
 PACKAGE OPTION
 1: TRAY
 2: TAPE REEL

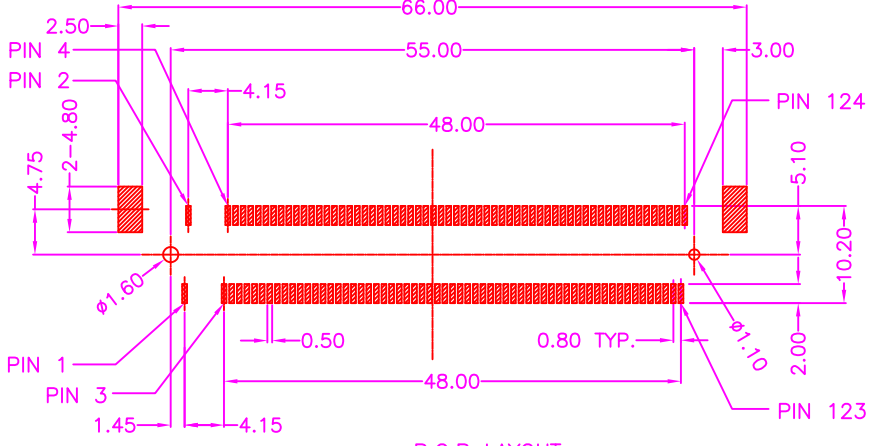
CONTACT PLATED OPTION ———— TIN PLATING ON SOLDER TAIL

- 1: GOLD FLASH
- 2: 2u" GOLD
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD



(FRONT SIDE)

(BACK SIDE)



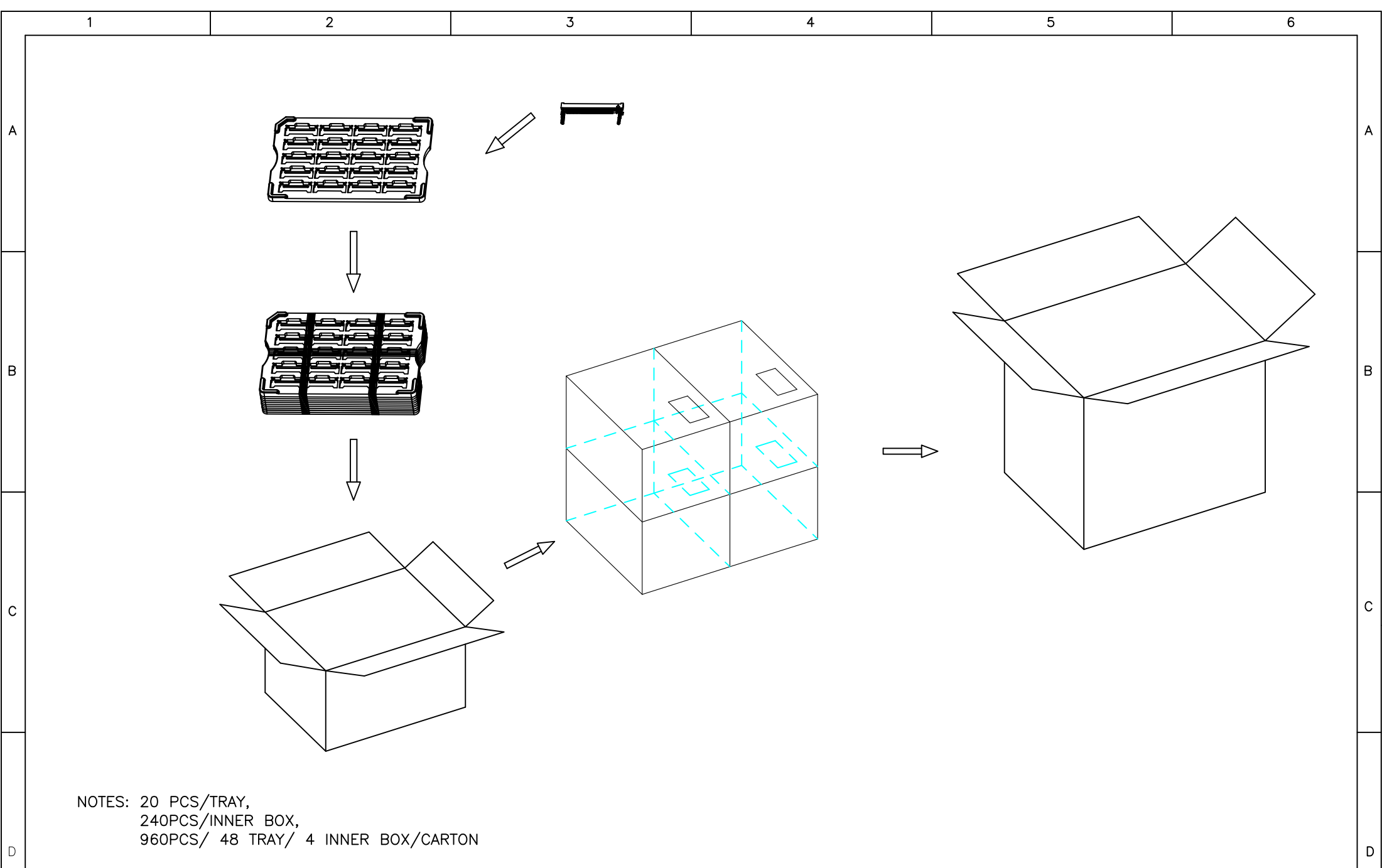
P.C.B. LAYOUT
TOP VIEW ±0.05



TOLERANCES	
X.±0.40	.XX±0.20
.X±0.30	.XXX±0.10

REV.	A	DRAWN BY	ISCO 2021/4/22	TITLE
		APPROVED BY	Lion 2021/4/22	DRAW NO.

MINI PCI SOCKET 124 PIN, 0.80mm PITCH, PCB MOUNT, SMT WITH LATCH & POST (H=5.60mm), FEMALE				
MMSLF-003	UNIT	MM	Sheet	2/3



NOTES: 20 PCS/TRAY,
 240PCS/INNER BOX,
 960PCS/ 48 TRAY/ 4 INNER BOX/CARTON



TOLERANCES	
X.±0.40	.XX±0.20
.X±0.30	.XXX±0.10

REV.	A

DRAWN BY	ISCO 2021/4/22
APPROVED BY	Lion 2021/4/22

TITLE	
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MINI PCI SOCKET 124 PIN, 0.80mm PITCH, PCB MOUNT, SMT WITH LATCH & POST (H=5.60mm), FEMALE				
MMSLF-003	UNIT	MM	Sheet	3/3